Manufacturing Info MBOI Specifications

PH4 ISPL (ATEC) (CU) MBOI Data

Supply
<u>Purchasing/Payables</u> Planning APSFR

Factory Information
Capacity Statement
Quality
Global EBR5 External Manufacturing MPE

Data Exchange Document and Data Exchange Intransit Exceptions

Search Files: 74VHC74MTCX-IPN Search MBOI Masters ASY (850) MEF (4) TST (925) Open Compliance (832)

Search text is highlighted in RED 74VHC74MTCX-IPN

	Ma	nufacturing Bill of Informatio	on (MBOI)		
Part Number	74VHC74MTCX-IPN-ASY	Part Type	Assembly Part		
Site Name Loc Cod	PH4 ISPL (ATEC) CU	File Name	PH4_74VHC74MTCX-IPN_74VHC74MTCX-IPN-ASY_ASY		
Flags	Non Safe Launch Item No Global Hold Flag	Part Qual Target Market:	I Industrial		
Part Version	4	Part Version Date-Time	2024-MAY-05 05:43:25 (GMT +7)		

	Orderable Part Section - OPN						
Part Number Desc	74VHC74MTCX-IPN DUAL D FLIP-FLOP	Market PN	74VHC74MTCX-IPN				
Lifecycle Phase	Production	Part Class Desc	AA ASSEMBLED AND TESTED				
Marketing Product Lifecycle	Follow Part Lifecycle	Part Sub Type	OPN				
Part Release Status Desc	MC-M Mass Production	Part Usage	STD				
Case Outline (CO)	948G PP	PAL4 Code Desc					
Product Data Sheet							
ERP Resource Code - ASY Desc	F304 TSSOP14 AU SNGL HPBF	OPN Part Qual Target Market	I Industrial				
Packing Configuration	TSSOP-14_948G_REEL_2500_FBQ5000	Eng Package Type	TSSOP-14				

Assembly_Part_Section - ASY							
Part Number	74VHC74MTCX-IPN-ASY	Description	DUAL D FLIP-FLOP				
Lifecycle Phase	Production	Part Usage	STD				
Part Release Status Desc	MC-M Mass Production	Part Sub Type	ASY				
PAL4 Code Desc	I	ERP Resource Code - ASY Desc	F304 TSSOP14 AU SNGL HPBF				
Part Qual Target Market	I Industrial						
Case Outline (CO)	948G DP	Package Type	TSSOP-14				
ECAT Override		Actual Lead Count	14				
Package Assembly Platform	SOSM - Small Outline Surface Mount	Assembly Baseline Spec					
Assembly Process Flow Spec		Assembly Spec(s) - Global					
Lot Processing Restrictions	Standard	Package Substrate Layout(s)					
ITAR Part Flag	N	Customs Configuration	8542.39.0001				
Customs ECCN Code	EAR99	Customer Consigned Flag	N				
Compressed?		Compressed Part Number					
Wettable Process Type		Wettable Flank Flag					
Site Notes							

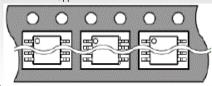
	BOM Components										
Alternate 002	Part Number	Part Sub Type	Line	Preference	Group	Qty	Description	Lifecycle Phase			
Primary Die	74VHC74-YCC3026D-WDQ WP	WDQ	001	01	0	1	Wafer 200	Production			
	Die Size (X + Y W/Scribe Street): 650 x 650						PDPW : 66834				
Package Kit	N17608G030	PKT	002	01	0	1	PKGKIT TSSOP14 CU (PH4)	Production			
	Piece Parts										
	1360100014	FRAME	010	01	0	1	LF TSSOP 14L JEDEC 4.4MM STAMPED PPF	Production			
	13601510002	EPXY	020	01	0	1	DA HE QMI519 2.5CC/5CC	Production			
	13601610001	WIRE	030	01	0	1	BW Au 0.8 MIL	Production			
	1360191000	MOLD	040	01	0	1	MC HITACHI CEL800JF 13MMX5.3G	Production			
BOI 67-Bonding Diagram	67AON20113G B	DOC	003	01	0	1	74VHC74x Series	Production			

Standard Marking Flag		
PB Free Mark Character Flag		
Consolidated Mark Machine Std	Consolidated Mark Machine Custom	Line1: \$Y&Z&2&K Line2: V74 Line3: UNK Line4: UNK Line5: UNK

Marking Details Section							
Date Code Type	S2						
Trace Code Legend - Front							
Trace Code Legend - Back							
Trace Code Spec	12MON45426G BD	Part Marking Source					
Part Marking Image/CAD Document		Marking Style Image Document					
Custom Logo Document		ON Logo Document					
Final Test Specification	48AON61241H O	48AON61241H O					

OPN Packing Section							
PCQ Container Desc	REEL Tape and Reel	PCQ Quantity					
MPQ Container Desc	REEL Tape and Reel	MPQ Quantity	2500				
Intermediate Full Box Container Type Intermediate Box Container Size Intermediate Full Box Container Quantity	 5000	Intermediate Full Bag Container Type Intermediate Bag Container Size Intermediate Full Bag Container Quantity	I				

Pin 1 Toward Upper Left



Labeling Section						
MSL 1 MSL Temperature 260						
Pb Free Leads Flag	Υ	Halide Free Flag	Υ			
Pb Free Die Attach Flag	Υ	Lead Finish Category (eCAT)	e4			

	Document Group Section						
Document Num	Revision	Release Date	Title				
12MON01117D	AC	15-Nov-23	Quality Assurance Inspection and Testing Sample Plan				
12MON03769D	Υ	04-Jul-22	External Visual Inspection Criteria				
12MON45426G BD 02-F		02-Feb-23	Mark Layout Instructions				
12MON49004E	12MON49004E AD 14-Apr-23		Subcontractors Bar Code Labeling				
12MRB17500B	FM	19-Sep-23	Finished Goods Packing and Long Term Storage Procedure				
48AON61241H O 05-Feb-24		27-Feb-24	Lot Combination Control Requirements for onsemi				
		05-Feb-24	74VHCxx, 74LCXxx & 74LVXxx Series				
		02-Feb-24	74VHC74x Series				

	BOM Links				
Up/Down Direction	Site	Top Part	Link		
Up	PH4	74VHC74MTCX-IPN	PH4_74VHC74MTCX-IPN_74VHC74MTCX-IPN-TST_TST.XML		

	Revision History					
Rev	Rev Rev Date Details					
4	2024-FEB-21 05:03:46	LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production PART_REL_DATE_PROD UPDATE_FILE_AND_VERSION previous_value:NULL;new_value:20-FEB-24				
3	2024-FEB-05 15:10:05	CONTROLLING_DOC UPDATE_FILE_AND_VERSION previous_value:48AON88777F;new_value:48AON61241H				

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2	2024-JAN-23 15:05:31	MARK_STYLE_SPEC_UPDATE_FILE_AND_VER PB_FREE_DIE_ATTACH_FLG_CONFIRM_REQU PB_FREE_IND_G_CD_IND_UPDATE_FILE_AND_ PB_FREE_LEADS_FLG_CONFIRM_REQUIRED_PIN1_IND_UPDATE_FILE_AND_VERSION_PROBLEM POLARITY_IND_UPDATE_FILE_AND_VERSION_ STD_MARK_FLG_UPDATE_FILE_AND_VERSION_	RED previous_value:NUL _VERSION previous_valu previous_value:NULL;new us_value:NULL;new_valu previous_value:NULL;new	L;new_value:Y e:NULL;new_va y_value:Y e:N/A v_value:NA		
1	2024-JAN-18 00:03:54	Initial version	. p. s sas aldo. 1,110w_v			

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